6.1

WHAT IS CLAIMED IS:

- 1. An aluminosilicate glass exhibiting a density less than about 2.45 g/cm³ and a liquidus viscosity greater than about 200,000 poises, the glass consisting essentially of the following composition as calculated in mol percent on an oxide basis: 65-75 SiO₂, 7-13 Al₂O₃, 5-15 B₂O₃, 0-3 MgO, 5-15 CaO, 0-5 SrO, and essentially free of BaO.
- 2. The glass of claim 1, wherein the RO/Al₂O₃ ratio is between 0.9 and 1.2, wherein R represents Mg, Ca, Sr and Ba.
- 3. The glass of claim 1, wherein the glass has a strain point greater than about 650 °C.
- 4. The glass of claim 1, wherein the glass has a linear coefficient of thermal expansion (CTE) over the temperature range 0-300 $^{\circ}$ C between 28-35 X10 $^{-7}$ / $^{\circ}$ C.
- 5. The glass of claim 4, wherein the glass has a strain point greater than about 660°C.
- 6. The glass of claim 4, wherein the glass has a melting temperature less than about 1700 °C.
- 7. The glass of claim 4, wherein the glass has a CTE of 28-33 X 10^{-7} /°C.
- 8. The glass of claim 1, wherein the glass exhibits a weight loss of less than 0.5 mg/cm² after immersion in a solution of 1 part 50 wt.% HF and 10 parts 40 wt. % NH₄F for 5 minutes at 30 °C.
- 9. The glass of claim 1, wherein the glass has a liquidus viscosity greater than about 400,000 poises.
- 10. A glass according to claim 1, wherein the glass has a liquidus viscosity greater than about 600,000 poises.
- 11. A glass according to claim 1, wherein the glass contains between 0-1 mole percent MgO when the glass contains no SrO.
- 12. In a flat panel display device, the improvement comprising a substrate in accordance with claim 1.
- 13. The flat panel display device of claim 12, wherein the substrate has an average surface roughness less than about 0.5 nm.

1

- 14. The flat panel display device of claim 12, wherein the substrate has an average internal stress less than about 150 psi.
- 15. A glass according to claim 1, wherein the glass has a composition consisting essentially of, as expressed in mol percent on an oxide basis: 67-73 SiO_2 , 8-11.5 Al_2O_3 , 8-12 B_2O_3 , 0-1 MgO, 5.5-11 CaO, and 0-5 SrO.
- 16. The glass of claim 15, wherein the glass has a strain point greater than about 650 °C.
- 17. The glass of claim 15, wherein the glass has a CTE of 28-33 X 10^{-7} /°C.
- 18. The glass of claim 17, wherein the glass has a strain point greater than about 660°C.
- 19. The glass of claim 17, wherein the glass has a melting temperature less than about 1700 °C.
- 20. The glass of claim 17, wherein the glass has a liquidus viscosity greater than 400,000 poises.
- 21. The glass of claim 17, wherein the glass has a liquidus viscosity greater than about 800,000 poises
- 22. In a flat panel display device, the improvement comprising a substrate in accordance with claim 17.
- 23. The flat panel display device of claim 22, wherein the substrate has an average surface roughness less than about 0.5 nm.
- 24. The flat panel display device of claim 22, wherein the substrate has an average internal stress less than about 150 psi.
- 25. In a flat panel display device, the improvement comprising a substrate in accordance with claim 21.
- 26. A substrate for a flat panel display device, wherein the substrate is comprised of a flat, transparent glass exhibiting a density less than about 2.40 g/cm³, a linear coefficient of thermal expansion (CTE) over the temperature range 0-300°C between 28-33 X10⁻⁷/°C and having a liquidus viscosity greater than about 400,000 poises, the glass consisting essentially of the following composition as calculated in mol percent on an oxide basis: 65-75 SiO₂, 7-13 Al₂O₃, 5-15 B₂O₃, 0-3 MgO, 5-15 CaO, 0-5 SrO, and essentially free

4.7

of BaO and the RO/Al $_2$ O $_3$ ratio is 0.92-0.96, wherein R represents Mg, Ca, Sr, and Ba.

- 27. A substrate according to claim 26, wherein the glass exhibits a strain point exceeding 660 °C.
- 28. The substrate according to claim 26, wherein the substrate has an average surface roughness less than about 0.5 nm.
- 29. The substrate according to claim 26, wherein the substrate has an average internal stress less than about 150 psi.